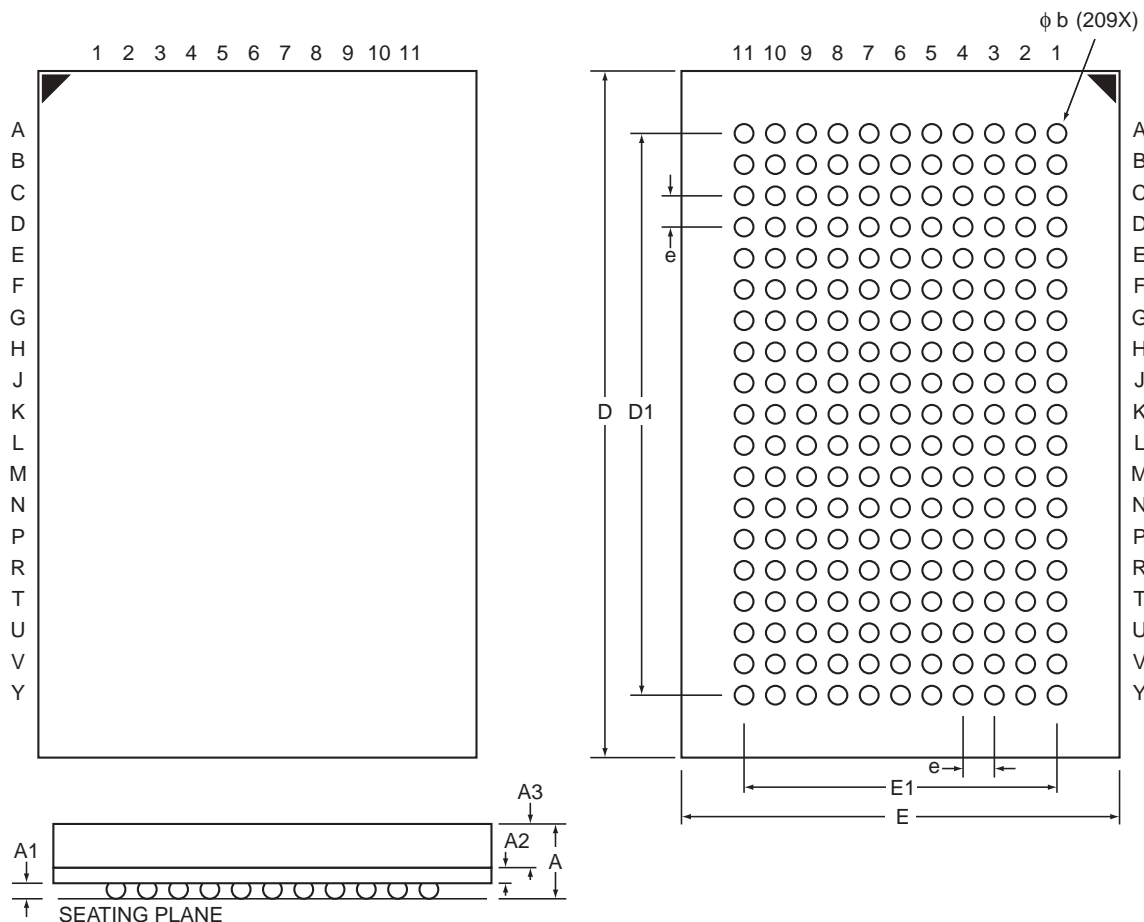


PACKAGING INFORMATION



Mini Ball Grid Array - 209 Ball BGA

Package Code: B (14 mm x 22mm Body, 1.0 mm Ball Pitch)



	MILLIMETERS			INCHES		
Sym.	Min.	Typ.	Max.	Min.	Typ.	Max.
NO. Leads 209						
A	—	—	1.95	—	—	0.077
A1	0.40	0.50	0.60	0.016	0.020	0.024
A2	—	0.54	—	—	0.021	—
A3	0.65	0.70	0.75	0.026	0.028	0.030
D	21.90	22.00	22.10	0.862	0.866	0.870
D1	18.00 BSC			0.709 BSC		
E	13.90	14.00	14.10	0.547	0.551	0.555
E1	10.00 BSC			0.394 BSC		
e	1.00BSC			0.039BSC		
b	0.50	0.60	0.70	0.020	0.024	0.028

Notes:
1. Controlling dimensions are in millimeters.

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